## MSG43004

## SiGe HBT type

**Transistors** 

### For low-noise RF amplifier

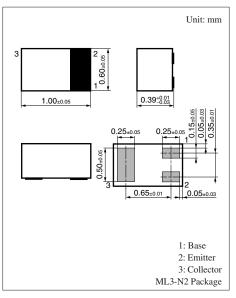
#### ■ Features

- Compatible between high breakdown voltage and high cut-off frequency
- Low noise, high-gain amplification
- Optimal size reduction and high level integration for ultra-small packages

## ■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter                             | Symbol           | Rating      | Unit |  |
|---------------------------------------|------------------|-------------|------|--|
| Collector-base voltage (Emitter open) | V <sub>CBO</sub> | 9           | V    |  |
| Collector-emitter voltage (Base open) | V <sub>CEO</sub> | 6           | V    |  |
| Emitter-base voltage (Collector open) | $V_{EBO}$        | 1           | V    |  |
| Collector current                     | $I_C$            | 100         | mA   |  |
| Collector power dissipation *         | P <sub>C</sub>   | 100         | mW   |  |
| Junction temperature                  | $T_{j}$          | 125         | °C   |  |
| Storage temperature                   | T <sub>sto</sub> | -55 to +125 | °C   |  |

Note) \*: Copper plate at the collector is 5.0 mm $^2$  on substrate at 10 mm  $\times$  12 mm  $\times$  0.8 mm.



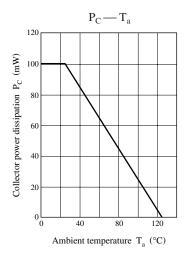
Marking Symbol: 5Y

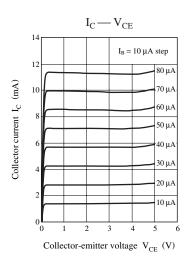
## ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

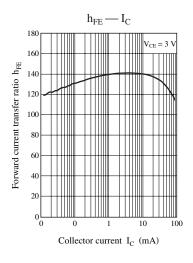
| Parameter                                    | Symbol               | Conditions   | Min | Тур | Max | Unit |
|--|----------------------|--|-----|-----|-----|------|
| Collector-base cutoff current (Emitter open) | $I_{CBO}$            | $V_{CB} = 9 \text{ V}, I_{E} = 0$                                |     |     | 1   | μΑ   |
| Collector-emitter cutoff current (Base open) | $I_{CEO}$            | $V_{CE} = 6 \text{ V}, I_{B} = 0$                                |     |     | 1   | μΑ   |
| Emitter-base cutoff current (Collector open) | $I_{EBO}$            | $V_{EB} = 1 \text{ V}, I_{C} = 0$                                |     |     | 1   | μΑ   |
| Forward current transfer ratio               | h <sub>FE</sub>      | $V_{CE} = 3 \text{ V}, I_{C} = 15 \text{ mA}$                    | 100 |     | 220 | _    |
| Transition frequency *                       | $f_T$                | $V_{CE} = 3 \text{ V}, I_{C} = 30 \text{ mA}, f = 2 \text{ GHz}$ |     | 17  |     | GHz  |
| Forward transfer gain *                      | S <sub>21e</sub>   2 | $V_{CE} = 3 \text{ V}, I_{C} = 30 \text{ mA}, f = 2 \text{ GHz}$ | 6.0 | 9.0 |     | dB   |
| Noise figure *                               | NF                   | $V_{CE} = 3 \text{ V}, I_{C} = 15 \text{ mA}, f = 2 \text{ GHz}$ |     | 1.4 | 2.0 | dB   |
| Collector output capacitance                 | C <sub>ob</sub>      | $V_{CB} = 3 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$             |     | 0.6 | 0.9 | pF   |
| (Common base, input open circuited) *        |                      |  |     |     |     |      |

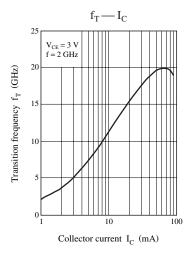
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

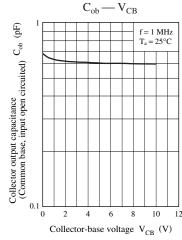
- 2. Observe precautions for handling. Electrostatic sensitive devices.
- 3. \*: Verified by random sampling

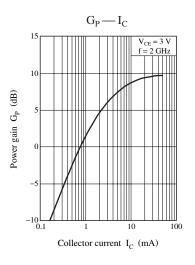


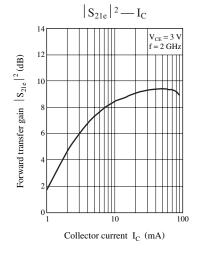


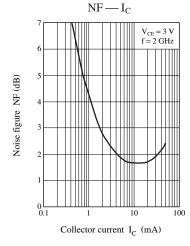


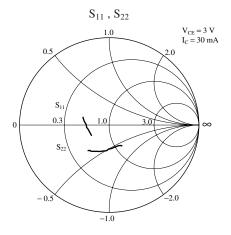


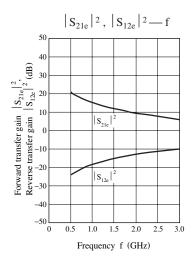












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